Low-power inverter with open-drain output

Rev. 1 — 31 January 2013

### 1. General description

The 74AUP1G06-Q100 provides the single inverting buffer with open-drain output. The output of the device is an open drain and can be connected to other open-drain outputs to implement active-LOW wired-OR or active-HIGH wired-AND functions.

Schmitt-trigger action at all inputs makes the circuit tolerant to slower input rise and fall times across the entire  $V_{CC}$  range from 0.8 V to 3.6 V.

This device ensures a very low static and dynamic power consumption across the entire  $V_{CC}$  range from 0.8 V to 3.6 V.

This device is fully specified for partial Power-down applications using  $I_{OFF}$ . The  $I_{OFF}$  circuitry disables the output, preventing the damaging backflow current through the device when it is powered down.

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

### 2. Features and benefits

- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
  - Specified from -40 °C to +85 °C and from -40 °C to +125 °C
- Wide supply voltage range from 0.8 V to 3.6 V
- High noise immunity
- Complies with JEDEC standards:
  - JESD8-12 (0.8 V to 1.3 V)
  - ◆ JESD8-11 (0.9 V to 1.65 V)
  - JESD8-7 (1.2 V to 1.95 V)
  - JESD8-5 (1.8 V to 2.7 V)
  - JESD8-B (2.7 V to 3.6 V)
- ESD protection:
  - MIL-STD-883, method 3015 Class 3A. Exceeds 5000 V
  - HBM JESD22-A114F Class 3A. Exceeds 5000 V
  - MM JESD22-A115-A exceeds 200 V (C = 200 pF, R = 0 Ω)
- Low static power consumption; I<sub>CC</sub> = 0.9 μA (maximum)
- Latch-up performance exceeds 100 mA per JESD 78 Class II
- Inputs accept voltages up to 3.6 V
- Low noise overshoot and undershoot < 10 % of V<sub>CC</sub>
- I<sub>OFF</sub> circuitry provides partial Power-down mode operation



Low-power inverter with open-drain output

## 3. Ordering information

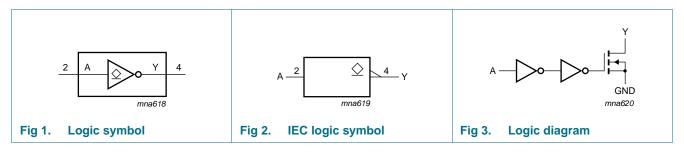
Table 1. Ordering information								
Type number	Package							
	Temperature range	Name	Description	Version				
74AUP1G06GW-Q100	–40 °C to +125 °C	TSSOP5	plastic thin shrink small outline package; 5 leads; body width 1.25 mm	SOT353-1				

## 4. Marking

Table 2. Marking	
Type number	Marking code <sup>[1]</sup>
74AUP1G06GW-Q100	pR

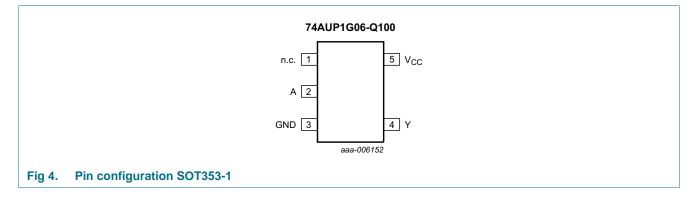
[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

## 5. Functional diagram



## 6. Pinning information

### 6.1 Pinning



74AUP1G06\_Q100
Product data sheet

Low-power inverter with open-drain output

### 6.2 Pin description

Table 3.	Pin description	
Symbol	Pin	Description
n.c.	1	not connected
А	2	data input
GND	3	ground (0 V)
Y	4	data output
V <sub>CC</sub>	5	supply voltage

## 7. Functional description

#### Table 4. Function table<sup>[1]</sup>

Input	Output
Α	Y
L	Z
Н	L

[1] H = HIGH voltage level;

L = LOW voltage level;

Z = high-impedance OFF state.

## 8. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		-0.5	+4.6	V
I <sub>IK</sub>	input clamping current	V <sub>I</sub> < 0 V	-50	-	mA
VI	input voltage		<u>[1]</u> –0.5	+4.6	V
I <sub>OK</sub>	output clamping current	V <sub>O</sub> < 0 V	-50	-	mA
Vo	output voltage	Active mode and Power-down mode	<u>[1]</u> –0.5	+4.6	V
lo	output current	$V_{O} = 0 V$ to $V_{CC}$	-	+20	mA
I <sub>CC</sub>	supply current		-	+50	mA
I <sub>GND</sub>	ground current		-50	-	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
P <sub>tot</sub>	total power dissipation	$T_{amb} = -40 \ ^{\circ}C$ to +125 $\ ^{\circ}C$	[2] _	250	mW

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] For TSSOP5 packages: above 87.5 °C the value of  $P_{tot}$  derates linearly with 4.0 mW/K.

Low-power inverter with open-drain output

## 9. Recommended operating conditions

Table 6.	Recommended operating conditi	ons			
Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		0.8	3.6	V
VI	input voltage		0	3.6	V
Vo	output voltage	Active mode	0	V <sub>CC</sub>	V
		Power-down mode; $V_{CC} = 0 V$	0	3.6	V
T <sub>amb</sub>	ambient temperature		-40	+125	°C
$\Delta t / \Delta V$	input transition rise and fall rate	$V_{CC} = 0.8 V \text{ to } 3.6 V$	0	200	ns/V

## **10. Static characteristics**

#### Table 7. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
T <sub>amb</sub> = 2	5 °C					
V <sub>IH</sub>	HIGH-level input voltage	$V_{CC} = 0.8 V$	$0.70\times V_{CC}$	-	-	V
		$V_{CC} = 0.9 V$ to 1.95 V	$0.65 \times V_{CC}$	-	-	V
		$V_{CC}$ = 2.3 V to 2.7 V	1.6	-	-	V
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	2.0	-	-	V
VIL	LOW-level input voltage	$V_{CC} = 0.8 V$	-	-	$0.30\times V_{CC}$	V
		$V_{CC} = 0.9 V$ to 1.95 V	-	-	$0.35 \times V_{CC}$	V
		$V_{CC}$ = 2.3 V to 2.7 V	-	-	0.7	V
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	-	-	0.9	V
V <sub>OL</sub>	LOW-level output voltage	$V_I = V_{IH}$ or $V_{IL}$				
		$I_{O}$ = 20 $\mu$ A; $V_{CC}$ = 0.8 V to 3.6 V	-	-	0.1	V
		I <sub>O</sub> = 1.1 mA; V <sub>CC</sub> = 1.1 V	-	-	$0.3\times V_{CC}$	V
		$I_0 = 1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$	-	-	0.31	V
		I <sub>O</sub> = 1.9 mA; V <sub>CC</sub> = 1.65 V	-	-	0.31	V
		$I_0 = 2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.31	V
		I <sub>O</sub> = 3.1 mA; V <sub>CC</sub> = 2.3 V	-	-	0.44	V
		$I_0 = 2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.31	V
		$I_{O} = 4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.44	V
I <sub>I</sub>	input leakage current	$V_I = GND$ to 3.6 V; $V_{CC} = 0$ V to 3.6 V	-	-	±0.1	μA
I <sub>OZ</sub>	OFF-state output current	$V_{I} = V_{IL}$ ; $V_{O} = 0$ V to 3.6 V; $V_{CC} = 0$ V to 3.6 V	-	-	±0.1	μΑ
I <sub>OFF</sub>	power-off leakage current	$V_1$ or $V_0 = 0$ V to 3.6 V; $V_{CC} = 0$ V	-	-	±0.2	μA
$\Delta I_{OFF}$	additional power-off leakage current	$      V_{I} \text{ or } V_{O} = 0 \text{ V to } 3.6 \text{ V};                                   $	-	-	±0.2	μΑ
I <sub>CC</sub>	supply current	$\label{eq:VI} \begin{array}{l} V_{I} = GND \text{ or } V_{CC}; \ I_{O} = 0 \ A; \\ V_{CC} = 0.8 \ V \ \text{to} \ 3.6 \ V \end{array}$	-	-	0.5	μΑ
$\Delta I_{CC}$	additional supply current	$V_{I} = V_{CC} - 0.6 \text{ V}; I_{O} = 0 \text{ A}; V_{CC} = 3.3 \text{ V}$	-	-	40	μΑ
CI	input capacitance	$V_{CC}$ = 0 V to 3.6 V; $V_{I}$ = GND or $V_{CC}$	-	0.8	-	pF
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Low-power inverter with open-drain output

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Co	output capacitance	output enabled; $V_O = GND$ ; $V_{CC} = 0 V$	-	1.7	-	pF
		output disabled; $V_O = GND$ ; $V_{CC} = 0 V$	-	1.1	-	pF
T <sub>amb</sub> = -4	40 °C to +85 °C					
VIH	HIGH-level input voltage	$V_{CC} = 0.8 V$	$0.70\times V_{CC}$	-	-	V
		$V_{CC} = 0.9 \text{ V} \text{ to } 1.95 \text{ V}$	$0.65 \times V_{CC}$	-	-	V
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.6	-	-	V
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	2.0	-	-	V
V <sub>IL</sub>	LOW-level input voltage	$V_{CC} = 0.8 V$	-	-	$0.30\times V_{CC}$	V
		$V_{CC} = 0.9 \text{ V} \text{ to } 1.95 \text{ V}$	-	-	$0.35 \times V_{CC}$	V
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	-	-	0.7	V
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	-	-	0.9	V
V <sub>OL</sub>	LOW-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$				
		$I_{O}$ = 20 $\mu$ A; $V_{CC}$ = 0.8 V to 3.6 V	-	-	0.1	V
		I <sub>O</sub> = 1.1 mA; V <sub>CC</sub> = 1.1 V	-	-	$0.3  imes V_{CC}$	V
		I <sub>O</sub> = 1.7 mA; V <sub>CC</sub> = 1.4 V	-	-	0.37	V
		I <sub>O</sub> = 1.9 mA; V <sub>CC</sub> = 1.65 V	-	-	0.35	V
		I <sub>O</sub> = 2.3 mA; V <sub>CC</sub> = 2.3 V	-	-	0.33	V
		I <sub>O</sub> = 3.1 mA; V <sub>CC</sub> = 2.3 V	-	-	0.45	V
		I <sub>O</sub> = 2.7 mA; V <sub>CC</sub> = 3.0 V	-	-	0.33	V
		$I_0 = 4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.45	V
l <sub>i</sub>	input leakage current	$V_I = GND$ to 3.6 V; $V_{CC} = 0$ V to 3.6 V	-	-	±0.5	μΑ
l <sub>oz</sub>	OFF-state output current	$V_{I} = V_{IL}$ ; $V_{O} = 0$ V to 3.6 V; $V_{CC} = 0$ V to 3.6 V	-	-	±0.5	μA
OFF	power-off leakage current	$V_{I}$ or $V_{O}$ = 0 V to 3.6 V; $V_{CC}$ = 0 V	-	-	±0.5	μA
$\Delta I_{OFF}$	additional power-off leakage current	$V_1$ or $V_0 = 0$ V to 3.6 V; $V_{CC} = 0$ V to 0.2 V	-	-	±0.6	μA
lcc	supply current	$\label{eq:VI} \begin{array}{l} V_{I} = GND \text{ or } V_{CC}; \ I_{O} = 0 \ A; \\ V_{CC} = 0.8 \ V \text{ to } 3.6 \ V \end{array}$	-	-	0.9	μA
۵l <sub>CC</sub>	additional supply current	$V_{I} = V_{CC} - 0.6 \text{ V}; I_{O} = 0 \text{ A}; V_{CC} = 3.3 \text{ V}$	-	-	50	μΑ
T <sub>amb</sub> = -4	40 °C to +125 °C					
VIH	HIGH-level input voltage	$V_{CC} = 0.8 V$	$0.75\times V_{CC}$	-	-	V
		$V_{CC} = 0.9 \text{ V} \text{ to } 1.95 \text{ V}$	$0.70 \times V_{CC}$	-	-	V
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.6	-	-	V
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	2.0	-	-	V
V <sub>IL</sub>	LOW-level input voltage	$V_{CC} = 0.8 V$	-	-	$0.25 \times V_{CC}$	V
	-	$V_{CC} = 0.9 \text{ V to } 1.95 \text{ V}$	-	-	$0.30 \times V_{CC}$	
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	-	-	0.7	V
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	-	-	0.9	V

### Table 7. Static characteristics ...continued

Low-power inverter with open-drain output

At recom	At recommended operating conditions; voltages are referenced to $GND$ (ground = 0 V).							
Symbol	Parameter	Conditions	Min	Тур	Max	Unit		
V <sub>OL</sub>	LOW-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$						
		$I_{O}$ = 20 $\mu A;$ $V_{CC}$ = 0.8 V to 3.6 V	-	-	0.11	V		
		$I_0 = 1.1 \text{ mA}; V_{CC} = 1.1 \text{ V}$	-	-	$0.33 \times V_{CC}$	V		
		$I_{O}$ = 1.7 mA; $V_{CC}$ = 1.4 V	-	-	0.41	V		
		$I_0 = 1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$	-	-	0.39	V		
		$I_0 = 2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.36	V		
		$I_0 = 3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.50	V		
		$I_0 = 2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.36	V		
		$I_0 = 4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.50	V		
I <sub>I</sub>	input leakage current	$V_{\rm I}$ = GND to 3.6 V; $V_{\rm CC}$ = 0 V to 3.6 V	-	-	±0.75	μA		
I <sub>OZ</sub>	OFF-state output current	$V_{\rm I}$ = $V_{\rm IL};$ $V_{\rm O}$ = 0 V to 3.6 V; $V_{\rm CC}$ = 0 V to 3.6 V	-	-	±0.75	μΑ		
I <sub>OFF</sub>	power-off leakage current	$V_{\rm I}~or~V_{\rm O}$ = 0 V to 3.6 V; $V_{\rm CC}$ = 0 V	-	-	±0.75	μA		
$\Delta I_{OFF}$	additional power-off leakage current	$      V_{I} \text{ or } V_{O} = 0 \text{ V to } 3.6 \text{ V};                                   $	-	-	±0.75	μΑ		
I <sub>CC</sub>	supply current	$\label{eq:VI} \begin{array}{l} V_{I} = GND \text{ or } V_{CC}; \ I_{O} = O \ A; \\ V_{CC} = 0.8 \ V \ to \ 3.6 \ V \end{array}$	-	-	1.4	μΑ		
$\Delta I_{CC}$	additional supply current	$V_{I}$ = $V_{CC}$ – 0.6 V; $I_{O}$ = 0 A; $V_{CC}$ = 3.3 V	-	-	75	μA		

#### Table 7. Static characteristics ... continued

## **11. Dynamic characteristics**

#### Table 8. **Dynamic characteristics**

Voltages are referenced to GND (ground = 0 V); for test circuit see <u>Figure 6</u>.

Symbo	Parameter	Conditions		25 °C		-40	) °C to +12	25 °C	Unit
			Min	Typ <mark>[1]</mark>	Max	Min	Max (85 °C)	Мах (125 °С)	
C <sub>L</sub> = 5	pF		1				l		
t <sub>pd</sub>	propagation delay	A to Y; see Figure 5	2]						
		$V_{CC} = 0.8 V$	-	12.8	-	-	-	-	ns
		$V_{CC}$ = 1.1 V to 1.3 V	2.3	4.3	9.9	2.0	10.9	12.0	ns
		$V_{CC}$ = 1.4 V to 1.6 V	1.8	3.1	6.1	1.5	7.1	7.8	ns
		$V_{CC}$ = 1.65 V to 1.95 V	1.5	2.8	4.7	1.2	5.7	6.3	ns
		$V_{CC}$ = 2.3 V to 2.7 V	1.2	2.2	3.2	1.0	3.9	4.3	ns
		$V_{CC}$ = 3.0 V to 3.6 V	1.1	2.2	3.3	0.8	3.6	4.0	ns
C <sub>L</sub> = 10	) pF								
t <sub>pd</sub>	propagation delay	A to Y; see Figure 5	2]						
		$V_{CC} = 0.8 V$	-	15.8	-	-	-	-	ns
		$V_{CC}$ = 1.1 V to 1.3 V	2.7	5.4	11.2	2.5	13.2	15.0	ns
		$V_{CC} = 1.4 \text{ V}$ to 1.6 V	2.2	3.9	7.0	2.0	8.5	9.4	ns
		$V_{CC}$ = 1.65 V to 1.95 V	1.9	3.6	5.4	1.7	6.7	7.4	ns
		$V_{CC}$ = 2.3 V to 2.7 V	1.7	2.9	3.8	1.4	4.5	5.0	ns
		$V_{CC}$ = 3.0 V to 3.6 V	1.6	3.2	4.6	1.2	4.9	5.4	ns
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#### Low-power inverter with open-drain output

Symbol	Parameter	Conditions	25 °C		-40	) °C to +12	25 °C	Unit	
			Min	Typ <mark>[1]</mark>	Max	Min	Max (85 °C)	Max (125 °C)	
C <sub>L</sub> = 15 j	ρF								
t <sub>pd</sub>	propagation delay	A to Y; see Figure 5	[2]						
		$V_{CC} = 0.8 V$	-	18.8	-	-	-	-	ns
		$V_{CC}$ = 1.1 V to 1.3 V	3.2	6.4	12.2	2.9	15.2	17.0	ns
		$V_{CC} = 1.4 \text{ V} \text{ to } 1.6 \text{ V}$	2.6	4.6	7.7	2.3	9.4	10.0	ns
		$V_{CC}$ = 1.65 V to 1.95 V	2.3	4.5	6.6	2.1	7.3	8.1	ns
		$V_{CC}$ = 2.3 V to 2.7 V	2.1	3.5	4.6	1.7	5.1	5.7	ns
		$V_{CC}$ = 3.0 V to 3.6 V	2.0	4.0	6.0	1.5	6.5	7.2	ns
C <sub>L</sub> = 30	ρF								
t <sub>pd</sub>	propagation delay	A to Y; see Figure 5	[2]						
		$V_{CC} = 0.8 V$	-	27.8	-	-	-	-	ns
		$V_{CC}$ = 1.1 V to 1.3 V	4.4	9.3	16.5	3.9	19.3	21.3	ns
		$V_{CC}$ = 1.4 V to 1.6 V	3.6	6.8	10.1	3.2	12.0	13.2	ns
		$V_{CC}$ = 1.65 V to 1.95 V	3.2	6.8	10.7	2.9	11.0	12.1	ns
		$V_{CC}$ = 2.3 V to 2.7 V	2.9	5.3	7.2	2.6	7.8	8.6	ns
		$V_{CC}$ = 3.0 V to 3.6 V	2.9	6.5	10.5	2.5	10.8	11.9	ns
C <sub>L</sub> = 5 pl	F, 10 pF, 15 pF and	30 pF							
C <sub>PD</sub>	power dissipation	$f_i = 1 \text{ MHz}; V_I = \text{GND to } V_{CC}$	<u>[3]</u>						
	capacitance	$V_{CC} = 0.8 V$	-	0.5	-	-	-	-	pF
		$V_{CC}$ = 1.1 V to 1.3 V	-	0.6	-	-	-	-	pF
		$V_{CC}$ = 1.4 V to 1.6 V	-	0.7	-	-	-	-	pF
		$V_{CC}$ = 1.65 V to 1.95 V	-	0.7	-	-	-	-	pF
		$V_{CC}$ = 2.3 V to 2.7 V	-	1.0	-	-	-	-	pF
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	-	1.2	-	-	-	-	pF

#### Dynamic characteristics ... continued Table 8.

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[1] All typical values are measured at nominal V<sub>CC</sub>.

[2]  $t_{pd}$  is the same as  $t_{PZL}$  and  $t_{PLZ}$ .

[3]  $C_{PD}$  is used to determine the dynamic power dissipation (P<sub>D</sub> in  $\mu$ W).

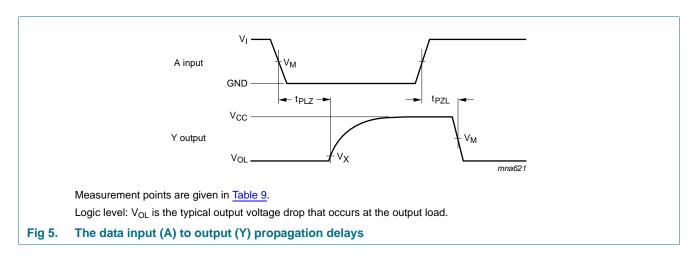
 $P_{D}$  =  $C_{PD} \times V_{CC}{}^{2} \times f_{i} \times N$  where:

 $f_i$  = input frequency in MHz;

 $V_{CC}$  = supply voltage in V; N = number of inputs switching.

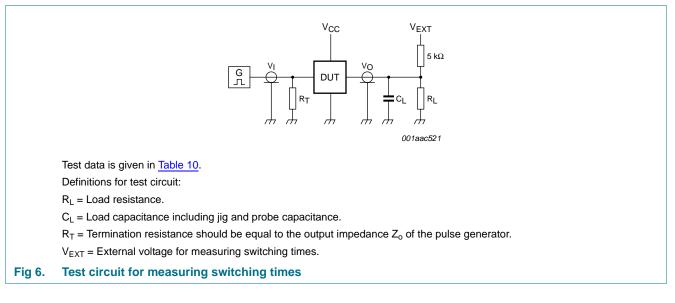
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## 12. Waveforms



#### Table 9. Measurement points

Supply voltage	Input	Output	
V <sub>cc</sub>	V <sub>M</sub>	V <sub>M</sub>	Vx
0.8 V to 1.6 V	$0.5  imes V_{CC}$	$0.5  imes V_{CC}$	V <sub>OL</sub> + 0.1 V
1.65 V to 2.7 V	$0.5\times V_{CC}$	$0.5  imes V_{CC}$	V <sub>OL</sub> + 0.15 V
3.0 V to 3.6 V	$0.5\times V_{CC}$	$0.5  imes V_{CC}$	V <sub>OL</sub> + 0.3 V



#### Table 10. Test data

Supply voltage	Load		V <sub>EXT</sub>		
V <sub>CC</sub>	CL	R <sub>L</sub> [1]	t <sub>PLH</sub> , t <sub>PHL</sub>	t <sub>PZH</sub> , t <sub>PHZ</sub>	t <sub>PZL</sub> , t <sub>PLZ</sub>
0.8 V to 3.6 V	5 pF, 10 pF, 15 pF and 30 pF	5 k $\Omega$ or 1 M $\Omega$	open	GND	$2\times V_{CC}$

[1] For measuring enable and disable times,  $R_L = 5 \text{ k}\Omega$ . For measuring propagation delays, setup and hold times and pulse width,  $R_L = 1 \text{ M}\Omega$ .

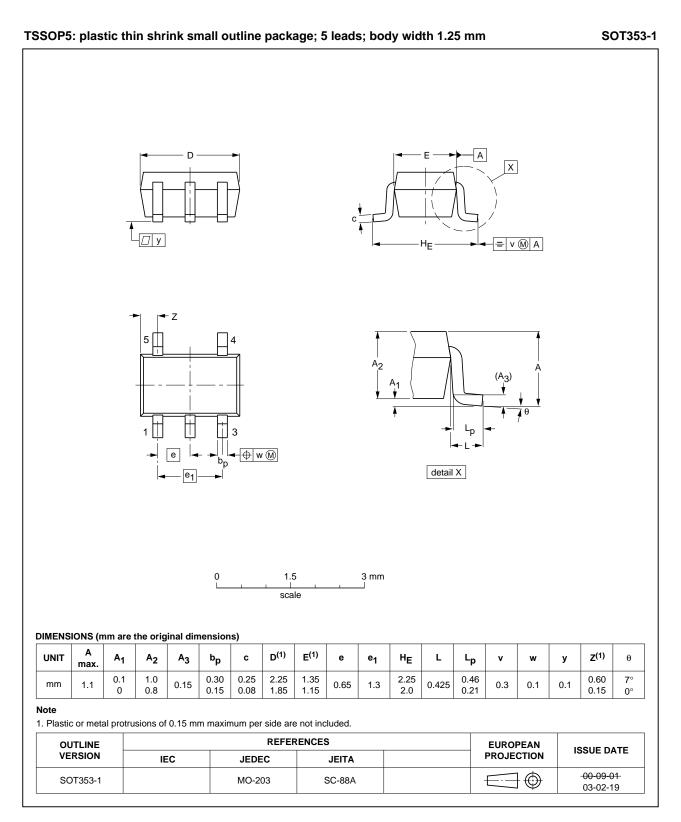
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### **NXP Semiconductors**

## 74AUP1G06-Q100

Low-power inverter with open-drain output

### 13. Package outline



#### Fig 7. Package outline SOT353-1 (TSSOP5)

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74AUP1G06\_Q100

Low-power inverter with open-drain output

## 14. Abbreviations

Table 11. At	bbreviations	
Acronym	Description	
CDM	Charged Device Model	
DUT	Device Under Test	
ESD	ElectroStatic Discharge	
HBM	Human Body Model	
MIL	Military	
MM	Machine Model	

## **15. Revision history**

Table 12. Revision history					
Document ID	Release date	Data sheet status	Change notice	Supersedes	
74AUP1G06_Q100 v.1	20130131	Product data sheet	-	-	

Low-power inverter with open-drain output

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Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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74AUP1G06 Q100

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74AUP1G06 Q100

Low-power inverter with open-drain output

### **18. Contents**

1	General description 1
2	Features and benefits 1
3	Ordering information 2
4	Marking 2
5	Functional diagram 2
6	Pinning information 2
6.1	Pinning 2
6.2	Pin description 3
7	Functional description 3
8	Limiting values 3
9	Recommended operating conditions 4
10	Static characteristics 4
11	Dynamic characteristics 6
12	Waveforms 8
13	Package outline 9
14	Abbreviations 10
15	Revision history 10
16	Legal information
16.1	Data sheet status 11
16.2	Definitions 11
16.3	Disclaimers
16.4	Trademarks 12
17	Contact information 12
18	Contents 13

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